

WP4090KA

Enhancement Mode N-Channel Power MOSFET

TO-252/NMOS/40V/±20V/1.7V/90A/4.0mΩ

Rev0.6





40V, 4.0mΩ, 90A, Single N-Channel

1.Features

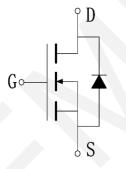
- ◆ 40V MOSFET technology
- Low on-state resistance
- Fast switching
- ♦ Vgs±20V

2.Applications

- Power Switching Application
- Load Switching



VD	s	R _{DS(on)} Typ.	I _D Max.
40		4.0mΩ @ 10V	004
40V	5.4mΩ @ 4.5V	90A	



Schematic Diagram

3.Package Marking and Ordering Information

Part no.	Marking	Package	PCS/Reel	PCS/CTN.	
WP4090KA	WP4090KA	TO-252	2,500	25,000	

4.Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Maximum	Units
Drain to Source Voltage	Vdss	40	V
Gate to Source Voltage	V _{GSS}	±20	V
Drain Current (DC)	lo	90	А
Drain Current (Pulse), PW≤300µs	I _{DP}	360	А
Total Dissipation	PD	50	W
Avalanche Energy, Single Pulsed	Eas	225	mJ
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



5.Thermal Resistance Ratings

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Rejc	2.5	°C/W

Note 2: When mounted on 1 inch square copper board t \leq 10sec The value in any given application depends on the user's specific board design.

6.Electrical Characteristics at Ta=25°C (Note 3)

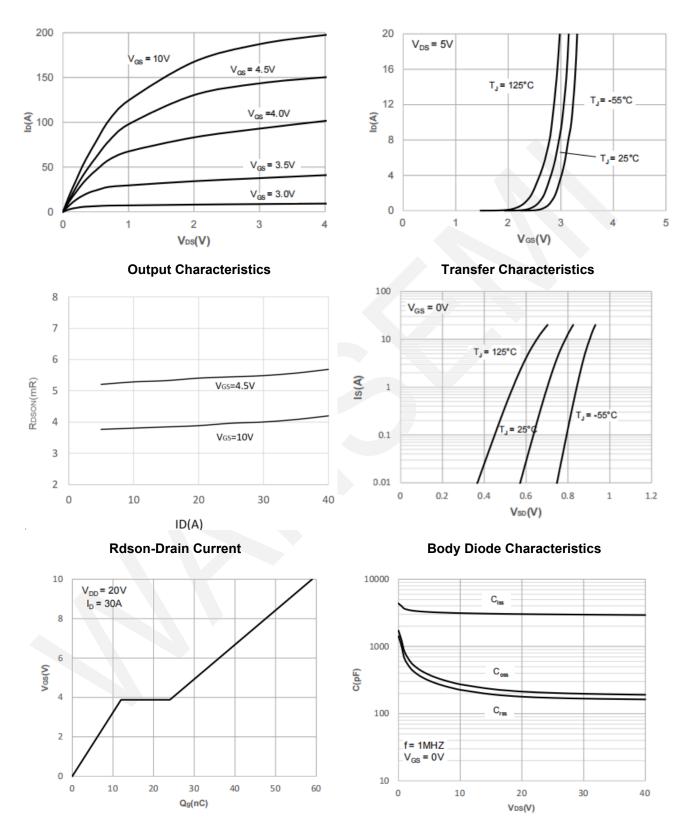
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Drain to Source Breakdown Voltage	V _{(BR)DSS}	I _D = 250µA, V _{GS} = 0V	40	-	-	V
Zero-Gate Voltage Drain Current	IDSS	V_{DS} = 40V, V_{GS} = 0V	-	T	1	uA
Gate to Source Leakage Current	Igss	V_{GS} = ±20V, V_{DS} = 0V	-	1	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} , I _{DS} =250µA	1	1.7	2.5	V
Static Drain to Source On-State	D	I _D = 30A, V _{GS} = 10V	1	4.0	5.5	mΩ
Resistance	R _{DS(on)}	I _D = 20A, V _{GS} = 4.5V	1	5.4	7.0	mΩ
Input Capacitance	Ciss	V _{GS} =0V,	-	3031	-	pF
Output Capacitance	Coss	V _{DS} =20V,	-	213	-	pF
Reverse Transfer Capacitance	Crss	Frequency=1.0MHz	-	179	-	pF
Turn-ON Delay Time	t _{d(on)}		-	12	-	ns
Rise Time	tr	V_{DD} = 20V, R_L = 1 Ω	-	11	-	ns
Turn-OFF Delay Time	$t_{d(off)}$	V_{GS} = 10V, R_G = 3 Ω	-	39	-	ns
Fall Time	tr		-	12	-	ns
	Qg	V _{DS} = 20V, V _{GS} = 10V, I _D = 30A	-	59	-	nC
Total Gate Charge	Qgs		-	12	-	nC
	Qgd		-	12	-	nC
Diode Forward Voltage	V _{FSD}	$I_{\rm S}$ = 20A, $V_{\rm GS}$ = 0	0.4	0.8	1.2	V

Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

WP4090KA



7. Typical electrical and thermal characteristics

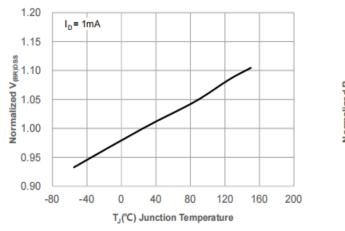


Gate Charge

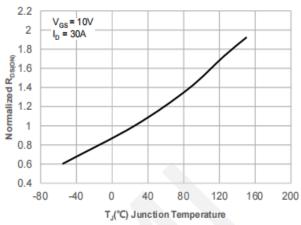
Capacitance Characteristics



WP4090KA

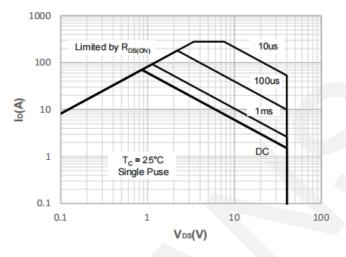


Normalized Breakdown voltage vs. Junction Temperature

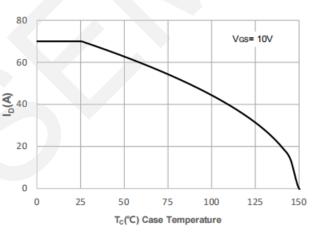


Normalized on Resistance vs.





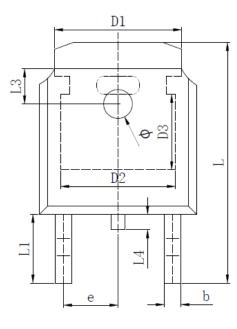
Maximum Safe Operating Area

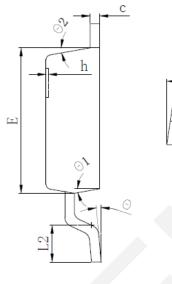


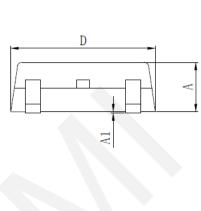
Maximum Continuous Drian Current vs. Case Temperature



8.Package Dimensions







		MILLIMETER		
SYMBOL	MIN	Тур.	MAX	
A	2. 200	2.300	2. 400	
A1	0.000		0. 127	
b	0.640	0.690	0.740	
c(电镀后)	0.460	0. 520	0. 580	
D	6.500	6. 600	6. 700	
D1	5.334 REF			
D2	4.826 REF			
D3	3.166 REF			
Е	6.000	6.100	6.200	
e		2.286 TYP		
h	0.000	0.100	0.200	
L	9.900	10.100	10.300	
L1	2.888 REF			
L2	1.400	1.550	1.700	
L3	1.600 REF			
L4	0.600	0.800	1.000	
φ	1.100	1.200	1.300	
θ	0°		8°	
θ1	9° TYP			
θ2	9° TYP			



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